GUANGDONG DONGYI HIGH-TECH MATERIAL SCIENCE&TECHNOLOGY CO., LTD.

品质承认书 Quality specification

客户 Customer:

供应商:广东东溢新材料科技有限公司

Supplier: GUANGDONG DONGYI HIGH-TECH MATERIAL SCIENCE&TECHNOLOGY CO., LTD.

产品类型 Product type: 环氧带胶铜箔 Epoxy adhesive copper foil

材料品名 Material name: P-E

编号 No:H010 版本 Ver: A4

制作日期 Date of production:2024/4/11

客户确认 Customer:

采购 Purchase:	品质 Quality:	工程 Engineering:
职务 Position:	职务 Position:	职务 Position:

备注 Note: (盖章 Seal)

广东东溢新材料科技有限 GUANGDONG DONGYI HIGH-		FECHNOLOGY CO., LTD.
业务 Marketing: 赵礼雄	品质 Quality:陈伟志	技术 Technical:侯松斌
职务 Position:总监	职务 Position:主管	职务 Position: 主管
备注 Note: (盖章 Seal)	TA	
14日 产于你由于学士豆		

地址: 广东省中山市南区昌盛路22号/板芙镇智创路1号 Address: No. 22 ChangSheng Road South District, ZhongShan City, GuangDong Province/No.1 ZhiChuang Road, Banfu Town 电话 TEL: 0760-88892754 88895714 23336599 传真 FAX: 0760-23336558

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HIGH-TECH MATERIAL SCIENCE&TECHNOLOGY CO., LTD. GUANGDONG DONGYI

产品名称 Product name

溢

DONGYI

序号	型号	胶厚(um)	铜厚(oz)	备注
No	Production Model	AD thickness	Copper thickness	Remark
1	P30-250E(MT)	30	1/3	
2	P22-250E(MO)	22	1/2	×
X				
				X

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GUANGDONG DONGYI HIGH-TECH MATERIAL SCIENCE&TECHNOLOGY CO., LTD.



■优异的耐热性和耐化学性 Excellent thermal resistance and chemical resistance

■优异的电性能和绝缘性 Outstanding electrical and insulation performance

■卓越的耐离子迁移特性 Excellent resistance migration

■无卤无锑,符合 ROHS 环保指令 Halogen & antimony free, ROHS compliant

●产品结构 Product Structure

铜箔Cu 环氧胶粘剂 Epoxy Adhesive 离型纸 Release paper

●编码原则 Product coding principle

品名示意图如下 The diagram as follows: 注:□:表示英文字母 X: 阿拉伯数字



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GUANGDONG DONGYI HIGH-TECH MATERIAL SCIENCE&TECHNOLOGY CO., LTD.

●物性指标 General Properties

DONGYI

		-			
序号 Item	性能项目 Test Item	单位 Unit	测试条件 TestCondition	标准 Standard	测试方法 Test Method
1	厚度 Thickness	um	A	标准 Standard ±10%	东溢规范 Dongyi Method
2	幅宽 Width	mm	А	一标准 Standard+2/-0	东溢规范 Dongyi Method
3	剥离强度 Peel Strength	N/mm	А	≧0.7	IPC-TM-650-2.4.9
4	耐化学品性 Chemical Resistance	%	HCl&NaOH 2mol/L	≦20	IPC-TM-650-2.3.2
5	焊锡耐热性 Solder Resistance		288°C/10S	无分层、起泡 No delamination, sparkling	IPC-TM-650-2.4.13
6	溢胶量 Resin Flow	mm	180°C/10s /100kgf/90s	0.05~0.30	IPC-TM-650-2.3.17.1
7	吸水率 Moisture Absorption	%	D-24/23	≦2.0	IPC-TM-650-2.6.2
8	表面电阻 Surface Resistance	Ω	C-96/23/65	$\geq 10^{10}$	IPC-TM-650-2.5.17
9	体积电阻 Volume Resistance	Ω.cm	C-96/23/65	$\geq 10^{12}$	IPC-TM-650-2.5.17
10	介电常数 Dielectric Constant		C-24/23/50 (10MHz)	≦4.0	IPC-TM-650-2.5.5.3
11	消耗因素 Dissipation Factor		C-24/23/50 (10MHz)	≦0.04	IPC-TM-650-2.5.5.3

注 Note: A 代表常态"A" Means normal。

外观管控 Appearance requirement

异常类型 Exception classes	异常大小 Abnormal size 允许个数 Allowed value (250*400mm)
杂质 Impurity	0.1~0.5mm ≦8 个 dots
垫伤 Pad injury	$\begin{array}{ll} 0.1^{\sim}0.5\text{mm} & \leq 8 \uparrow \text{dots} \\ 0.5^{\sim}1\text{mm} & \leq 1 \uparrow \text{dots} \end{array}$
气泡 Bubble	≧1mm 不允许Not allowed
接头 Joint	≦3↑

注Note: 产品边缘 3mm 以内异常, 不作管控要求 From the product within 3 mm of the edge of exception, don't do control requirements.

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GUANGDONG DONGYI HIGH-TECH MATERIAL SCIENCE&TECHNOLOGY CO., LTD.

●储存 Storage

温度<10℃、湿度<70% RH、真空包装、无腐蚀性气体的室内,制造日期后 保存3个月。Temperature<10℃,humidity<70% RH,airproof vacuumed packaging, no corrosive gas chamber for 3 months。

●包装 Packing

1. 每一卷成品用管芯卷取。每批出货的每个规格提供一份品质检验报告 Each volume of finished tube winding。

2. 每一卷成品用纸箱包装,避免在运输上碰撞。产品采用防潮、干燥、密封包装,成卷装入纸箱 Each volume of finished carton packaging, in the transport collision avoidance. Products using moistureproof, dry, sealed packaging, rolls into cartons。

包箱标签 Package box label
无卤标签 Halogen free label: 环保标签 Green label: 合格标签 Inspection tag:



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D装运 Shipment

DONGYI

每批提供一份质量检验报告,如下表(出货检验报告仅供参考):Each shipment of each specification provides a quality inspection report. The following table (Report format for reference only):

	带胶铜箔出	厂检验报告	编号:JL-Q-02-004-09	
日期(Date):		客户(customer):		
品名(Material	品名(Material spec)		P30-250E(MT)	
批号(Lot N	o.)			
保存期限(Shelf	保存期限(Shelf life)		<10℃, <70%RH保存3个月 (Below 10℃, 70%RH for 3months)	
检验项目 (Test item)	检验方法 (Test method)	品质标准 (Quality Spec)	测试结果 (Test Result)	
Adhesive+cu总厚度 (Adhesive+cu thickness)	东溢规范 (Unit:μm)	42 ±10%		
幅宽 (Width)	东溢规范 (Unit:mm)	250 +2/-0		
溢胶量 (Resin flow)	东溢规范 (Unit:mm)	0.05-0.3		
剥离强度 (Peel Strength)	IPC-TM-650 2.4.9 (Unit:kgf/cm)	≧0.7		
焊锡耐热性 (Solder Float Resistance) 288℃/10sec	IPC-TM-650 2.4.13	无分层起泡 (No Blistering or Delamination)	1	
	产品判定结果			
备注:			-	
1. 以上测试数据仅供参考。				
2.E胶膜适用于FPC线路多层机 3.上述产品不含[RoHS]所规题				

地址: 广东省中山市南区昌盛路22号 电话: 0760-23338784 传真: 0760-23336558 邮编: 528455

审核(APPROVED BY):

检验员(CHECKED BY):

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●使用注意事项 Matters needing attention

1. 如产品被放置在低于 10 度以下储存环境,建议客户在使用前将产品静置 4 小时 以上回暖直至产品温度回升至室温温度(20--30℃)后方才使用、以确保最佳产品 使用特性,同时也应避免放置在阳光直接照射及高温环境下 if product was placed in under Temperature 10℃for storage, the product should be placed in the room temperature20~30℃ more than 4 hoursbefore using, in order to make the product temperature up to 20~30℃, to ensure the best product features. At the same time should also avoid placing it in direct sunlight and high temperature environment.

2. 如果客户制程没有温湿度管控, 建议开料后的带胶铜箔在所有制程流转中, 加装 在密封袋中保存, 防止吸潮影响产品性能。If the client process there is no temperature and humidity control, suggested that cutting epoxy adhesive copper foil in the process flow of system of ownership, add in a sealed bag, prevent epoxy adhesive copper foil absorption of moisture influence increases.

3. 压合后的产品建议使用千层架烘烤,如无千层架建议叠层张数不超过 20PNL,以 避免叠层太多而影响产品固化效果。Pressing products recommend the use of multi-layer frame, such as no proposal for multi-layer frame lamination number no more than 20 PNL, to avoid the laminated too much and influence product curing effect.

4. 此规格书中表述的所有测试数据以及建议之工艺条件和参数仅供参考,产品使用 方需要按照自身实际生产设备及产品要求等因素自行确认最优生产工艺及作业参数。 特此声明! Hereby declared that all test data and recommended process conditions and operating parameters presented in this technical datasheet are for informational purposes only. Product users need to confirm the optimal production process and operating parameters according to their actual production equipment and product requirements.

●物性测试方法 PropertiesTest Method

剥离强度检验方法 Peel Test Method

1、范围 The range:

本检验方法适用本公司带胶铜箔产品剥离强度之量测。This test method

for epoxy adhesive foilmeasurement of peel strength.

2、检测仪器 Testing instruments:

₹剥离强度测试仪 Peel strength testing instruments

3、样品制作 The sample:

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a)将带胶铜箔切成 10cm×10cm 大小,与大小一致的纯铜箔贴合(胶厚≥25 μ m,用 10Z ED 铜箔贴合;胶厚<25 μ m,用 1/20Z ED 铜箔贴合)。Epoxy adhesive copper foil cut into 10 cm by 10 cm size, consistent with the size of copper foil laminating (≥ 25 um, with 10Z ED copper foil laminating; < 25 um, 1/20Z ED with copper foil laminating).

b)将带胶铜箔平放在铜箔光面上, 放入 100℃过塑机过一遍。Epoxy adhesive copper foilon the smooth surface of copper foil, in the 100 ℃ molding machine again.

c)快压:温度180℃、压力100kgf/cm2、预热10s、成型90s;熟化:160 ℃ × 60min;Quickpressure:temperature180℃,pressure100kgf/cm2,Time10 s,90 s;Cure:160 ℃ x 60 min.

4、样品测试 The sample test:

a)取熟化过后之样片, 裁切 1cm 宽度, 烧开使得铜箔与铜箔分开然后用手 撕开约 3cm。Take samples after curing, cutting1 cm width to boil make copper foil is separated from copper foil.

b)把样品用双面胶固定在测试仪的滚轮上,用夹具夹住铜箔一端,与滚轮 垂直,然后匀速上升,每隔1秒,按打印机一次,共打印出15~30个数据即可, 取打印数据的平均值作为此条样品的剥离强度值。The samples with double-sided adhesive fixed on the roller tester, fixture for clipping the copper foil at one end, and vertical roller, and then rising at a constant speed, every 1 second, print 1 data, print out together 15[~]30 data, take the print data as the average of the peel strength value of this sample.

c)注意事项:剥离机上升速度: 50mm/min,剥离距离: 10~20mm; 拉铜箔、 样品与滚轮垂直。Note: machine rise: 50 mm/min, stripping distance: 10[~] 20 mm; Pull copper foil, samples and vertical roller.

5、公式计算 Formula to calculate:

拉力Tensile force(kgf)

▲ 剥离强度 Peel strength=

宽度 The width (cm)

注: 以上规范参考 IPC-TM-650, Method 2.4.9. Note: The above specification reference IPC - TM - 650, Method 2.4.9.

溢胶量检验方法 Resin Flow Test Method

1. 范围 The range:

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本检验方法适用于本公司产品中带胶铜箔溢胶量之量测。This test method for epoxy adhesive copper foilmeasurement of resin flow.

- 检测设备 Testing instruments: 冲孔机、过塑机、快压机、镜像显微镜。Punching machine, laminator, press microscope.
- 3. 样品制作 The sample:

取试样尺寸 25mm*40mm, 依次冲出Φ6.4mm、Φ4.8mm、Φ2.4mm 、Φ1.6mm 的四个圆孔, 同时在孔下方再依次冲出 3mm×2mm、2mm×2mm、1mm×2mm 的三个 方孔, 如下图所示: Take the sample size 25mm*40mm, punching Φ6.4mm, Φ 4.8mm, Φ2.4mm, Φ1.6mm four holes, and then punching3mm*2mm, 2mm*2mm, 1mm * 2mm three square holes, as shown below:



如有条件,可按 IPC-TM-650, Method 2.3.17.1 制图: If there are conditions, according to Method, 2.3.17.1 IPC-TM-650 to make samples:



4. 压合方法 Pressing method:

a)将带胶铜箔样品与半对半双面压延覆铜箔帖合,然后用 100℃过塑机过一遍。 Epoxy adhesive copper foil on the smooth surface of copper foil, in the 100 ℃ molding machine again.

b)放入快压机时,垫上绿硅胶,上下用 25μm 离型膜夹住样品,快压:温度 180℃、 压力 100 kg f/cm²、预压 10s、成型 90s。Quick pressure: temperature 180℃, pressure 100 kgf/cm2, Time10 s, 90 s; Cure: 160 ℃ x 60 min.

5. 溢胶量判定 Determination of resin flow:

利用镜像显微镜量测覆盖膜之接着剂溢胶情况,利用接目镜 10 倍数和接物镜 3.5 倍数来测试。分别观测并记录不同孔径的之最大溢胶刻度值,再取各孔径平均值 即为测试值。By microscope measurements resin flow, the eyepiece and objective 10times to 3.5 times. Observed and recorded the biggest different aperture of resin flow scale value, then the aperture average is the test value. 注:以上规范参考 IPC-TM-650, Method 2. 3. 17. 1; Note: The above specification 此规格书为东溢公司机密文件且涉及专利保护事宜,未经东溢公司书面签章确认同意严禁转载转发,此规格书中所有条款内容最终解释权归东溢公司所有. 特此声明! Hereby declared that this technical datasheet is a confidential document of Dongyi and involves patent protection matters, reproduction and forwarding without the written permission of Dongyi Company is strictly prohibited, the final interpretation of all the terms and conditions in this technical datasheet belongs to Dongyi

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